

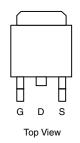
RoHS

COMPLIANT

N-Channel 200 V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|--------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | | |
| 200 | 0.048 at V _{GS} = 10 V | 40 | | |
| | 0.060 at V _{GS} = 6.5 V | 35 | | |



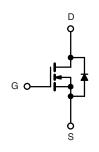


FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- PWM Optimized for Fast Switching
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Isolated DC/DC Converters
 - Primary-Side Switch



N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|---|-------------------------------------|-----------------------------------|------------------|----|--|
| Drain-Source Voltage | V _{DS} | 200 | - v | | |
| Gate-Source Voltage | V _{GS} | ± 20 | | | |
| Continuous Drain Current ($T_1 = 175 \text{ °C}$) | T _C = 25 °C | 1- | 40 | | |
| $Continuous Drain Current (T_j = 175 C)$ | T _C = 125 °C | I _D | 25 | | |
| Pulsed Drain Current | I _{DM} | 80 | A | | |
| Avalanche Current | I _{AR} | 20 | | | |
| Repetitive Avalanche Energy ^a | L = 0.1 mH | E _{AR} | 16.2 | mJ | |
| | T _C = 25 °C | P | 200 ^b | W | |
| Maximum Power Dissipation ^a | T _A = 25 °C ^c | | 4.5 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------|---------------------------------|-------------------|-------|------|--|--|
| Parameter | | Symbol | Limit | Unit | | |
| Junction-to-Ambient | PCB Mount (TO-263) ^c | R _{thJA} | 40 | °C/W | | |
| Junction-to-Case (Drain) | | R _{thJC} | 1 | C/VV | | |

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | |
|--|----------------------|--|-------|-------|-------|------|
| Parameter | Symbol | Test Conditions | Min . | Тур. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{GS} = 0 V, I _D = 250 µA | 200 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 2 | | 4 | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | | $V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | μΑ |
| | I _{DSS} | $V_{DS} = 160 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | 50 | |
| | | $V_{DS} = 160 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$ | | | 250 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 15 \text{ V}, V_{GS} = 10 \text{ V}$ | 60 | | | А |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.048 | | Ω |
| Drain-Source On-State Resistance ^a | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | | 0.150 | | |
| | R _{DS(on)} | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 175 ^{\circ}\text{C}$ | | 0.180 | | |
| Drain-Source on State Resistance | | V _{GS} = 6.5 V, I _D = 15 A | | 0.060 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 15 | | | S |
| Dynamic ^b | • | | 4 | • | ł | |
| Input Capacitance | C _{iss} | | | 2820 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 300 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 120 | | |
| Total Gate Charge ^c | Qg | | | 35 | | nC |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$ | | 11 | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 14 | | |
| Gate Resistance | R _G | | | 2 | | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 15 | 25 | ns |
| Rise Time ^c | t _r | V_{DD} = 100 V, R _L = 5 Ω I _D \cong 20 A, V _{GEN} = 10 V, R _G = 2.5 Ω | | 35 | 55 | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 40 | 60 | |
| Fall Time ^c | t _f | | | 30 | 45 | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) ^b | | • | | |
| Continuous Current | ۱ _S | | | | 40 | ^ |
| Pulsed Current | I _{SM} | | | | 60 | A |
| Forward Voltage ^a | V _{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | | | 115 | 170 | ns |
| Peak Reverse Recovery Charge | I _{RM(REC)} | I _F = 50 A, dl/dt = 100 A/μs | | 7.5 | 12 | А |
| Reverse Recovery Charge | Q _{rr} | | | 0.43 | 1.02 | μC |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

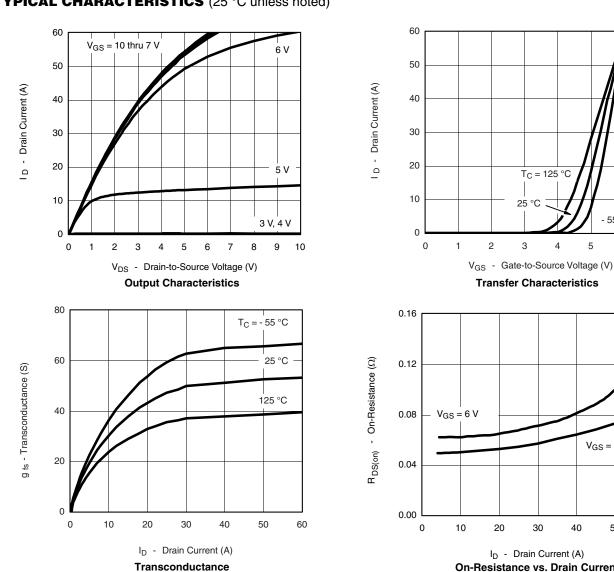
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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• 55 °C

V_{GS} = 10 V



 \mathbf{C}_{iss}

Coss

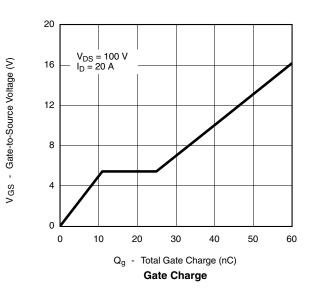
V_{DS} - Drain-to-Source Voltage (V) Capacitance

TYPICAL CHARACTERISTICS (25 °C unless noted)

I_D - Drain Current (A) **On-Resistance vs. Drain Current**

T_C = 125 °C

25 °C

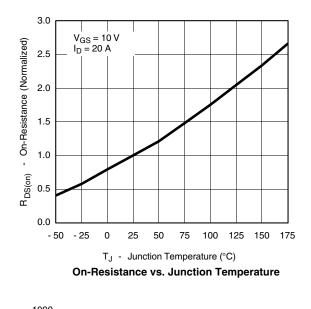


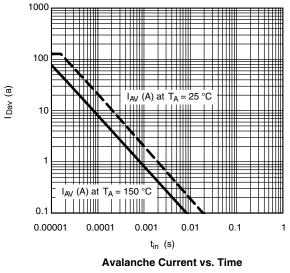
 C_{rss}

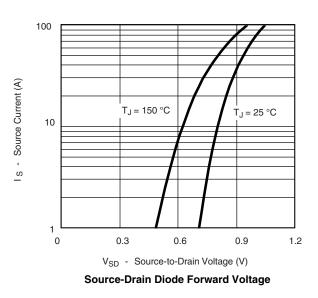
C - Capacitance (pF)

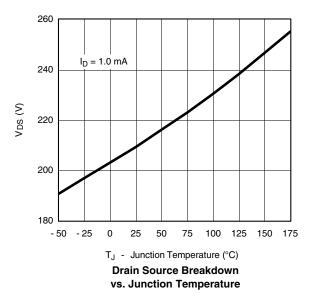


TYPICAL CHARACTERISTICS (25 °C unless noted)





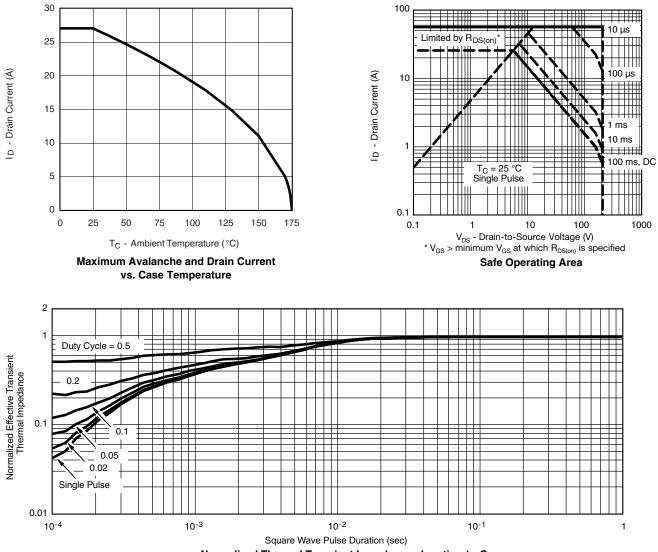




AUIRFS4620



THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



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